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Dated: March 17, 2006

Signature: 

Linda J. Werk

Ref.: 7452-105/10313554  
(PATENT)

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Patent Application of:  
Shih-Ping Hsu

Confirmation No.: 6002

Application No.: 10/695,356

Group Art Unit: 2812

Filed: October 27, 2003

Examiner: Chen, Jack

For: SEMICONDUCTOR PACKAGE  
SUBSTRATE HAVING CONTACT PAD  
PROTECTIVE LAYER FORMED THEREON  
AND METHOD FOR FABRICATING THE  
SAME

**STATEMENT OF SUBSTANCE OF INTERVIEW**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

This will report the telephone interview conducted February 28, 2006 at which Mr. Berliner, the attorney for applicant, confirmed that claims 7-13 read on the elected species I (figs. 3A-3I).

**REMARKS**

The Commissioner is hereby authorized to charge any fee which should have been


Application No.: 10/261,796

Docket No.: LA-7280-101.US

filed herewith to our Deposit Account No. 50-0337, under Order No. LA-7452-105/10313554. A duplicate copy of this paper is enclosed.

Dated: March 17, 2006

Respectfully submitted,

By   
Robert Berliner  
Registration No.: 20,121  
FULBRIGHT & JAWORSKI L.L.P.  
555 South Flower; 41st Floor  
Los Angeles, California 90071  
(213) 892-9200  
(213) 892-9494 (Fax)  
Attorneys for Applicant